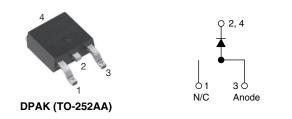
## VS-8EWH06FNHM3

Vishay Semiconductors

Hyperfast Rectifier, 8 A FRED Pt<sup>®</sup>



www.vishay.com

SHAY

PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub>	8 A				
V <sub>R</sub>	600 V				
V <sub>F</sub> at I <sub>F</sub>	1.3 V				
t <sub>rr</sub> (typ.)	18 ns				
T <sub>J</sub> max.	175 °C				
Package	DPAK (TO-252AA)				
Circuit configuration	Single				

### **FEATURES**

- Hyper fast recovery time, reduced Qrr and soft recovery
- 175 °C maximum operating junction temperature
- For PFC CRM/CCM operation
- · Low forward voltage drop
- · Low leakage current
- AEC-Q101 qualified
- Meets JESD 201 class 2 whisker test
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **DESCRIPTION / APPLICATIONS**

State of the art hyper fast recovery rectifiers designed with optimized performance of forward voltage drop, hyperfast recovery time, and soft recovery.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in PFC boost stage in the AC/DC section of SMPS inverters or as freewheeling diodes. Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Peak repetitive reverse voltage	V <sub>RRM</sub>		600	V		
Average rectified forward current	I <sub>F(AV)</sub>	T <sub>C</sub> = 143 °C	8			
Non-repetitive peak surge current	I <sub>FSM</sub>	T <sub>J</sub> = 25 °C	90	А		
Peak repetitive forward current	I <sub>FM</sub>	$T_C$ = 143 °C, f = 20 kHz, d = 50 %	16			
Operating junction and storage temperatures	T <sub>J</sub> , T <sub>Stg</sub>		-65 to +175	°C		

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Breakdown voltage, blocking voltage	V <sub>BR</sub> , V <sub>R</sub>	I <sub>R</sub> = 100 μA	600	-	-	
Forward voltage	V	I <sub>F</sub> = 8 A	-	2.0	2.4	V
Forward voltage V <sub>F</sub>	I <sub>F</sub> = 8 A, T <sub>J</sub> = 150 °C	-	1.3	1.8		
Povoroo lookago ourront		$V_{R} = V_{R}$ rated	-	-	50	
Reverse leakage current I <sub>R</sub>		$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	-	500	μA
Junction capacitance	CT	V <sub>R</sub> = 600 V	-	8	-	pF
Series inductance	L <sub>S</sub>	Measured lead to lead 5 mm from package body	-	8	-	nH

Revision: 11-Apr-18

Document Number: 94739 For technical questions within your region: DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000



RoHS

COMPLIANT

HALOGEN

FREE

1





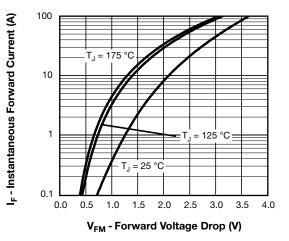
<b>DYNAMIC RECOVERY CHARACTERISTICS</b> ( $T_J = 25$ °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS		
		$I_F = 1 \text{ A}, dI_F/dt = 50$	$I_F = 1 \text{ A}, dI_F/dt = 50 \text{ A}/\mu \text{s}, V_R = 30 \text{ V}$		21			
	+	$I_F = 1 \text{ A}, \text{ d}I_F/\text{d}t = 100 \text{ A}/\mu\text{s}, \text{ V}_R = 30 \text{ V}$		-	18	22		
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	25	-	ns	
		T <sub>J</sub> = 125 °C	$I_F = 8 A$	-	34	-		
Pool room ourrent	1	T <sub>J</sub> = 25 °C		-	3.3	-	А	
Peak recovery current I <sub>RRM</sub>	T <sub>J</sub> = 125 °C	dI <sub>F</sub> /dt = 200 A/µs V <sub>B</sub> = 390 V	-	4.8	-	~		
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	39	-	nC	
		T <sub>J</sub> = 125 °C		-	90	-		

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-65	-	175	°C
Thermal resistance, junction to case per leg	R <sub>thJC</sub>		-	1.8	2.2	°C/W
Approvimeto weight				0.3		g
Approximate weight				0.01		oz.
Marking device		Case style DPAK (TO-252AA)		8EWH	06FNH	

Revision: 11-Apr-18

Document Number: 94739

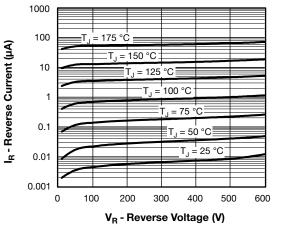


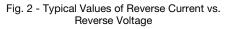


www.vishay.com

ISHAY

Fig. 1 - Typical Forward Voltage Drop Characteristics





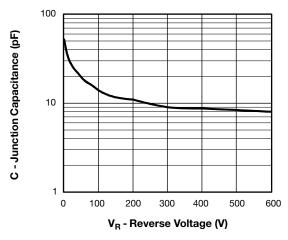
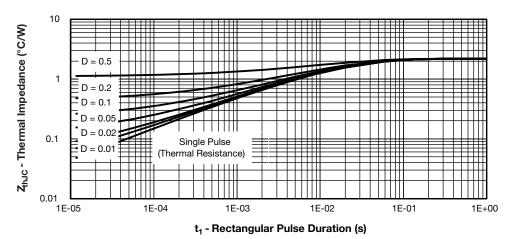
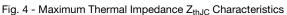


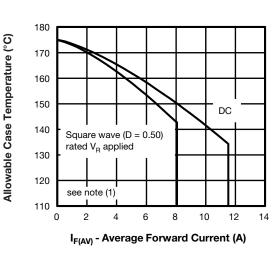
Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage





Revision: 11-Apr-18





www.vishay.com

**ISHAY** 

Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

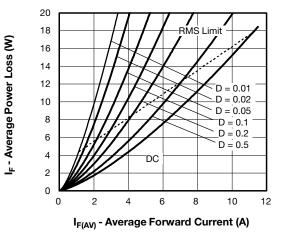


Fig. 6 - Forward Power Loss Characteristics

#### Note

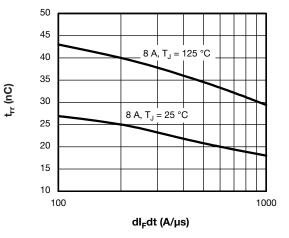


Fig. 7 - Typical Reverse Recovery Time vs. dI<sub>F</sub>/dt

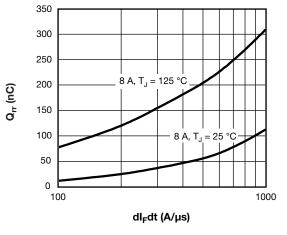


Fig. 8 - Typical Stored Charge vs. dl<sub>F</sub>/dt

Revision: 11-Apr-18

Document Number: 94739

For technical questions within your region: DiodesAmericas@vishay.com, DiodesAsia@vishay.com, DiodesEurope@vishay.com THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <a href="http://www.vishay.com/doc?91000">www.vishay.com/doc?91000</a>

4



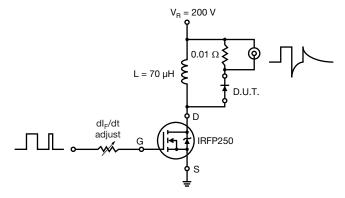
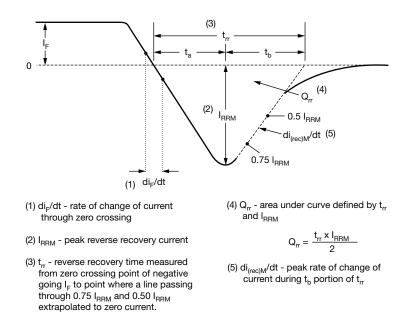
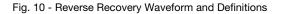


Fig. 9 - Reverse Recovery Parameter Test Circuit





Revision: 11-Apr-18

SHAY

www.vishay.com

5

## VS-8EWH06FNHM3

www.vishay.com

VISHAY

Vishay Semiconductors

ORDERING INFORMATION TABLE

Device code	VS-	8	E	w	н	06	FN	TRL	н	М3
	1	2	3	4	5	6	7	8	9	10
	1	- Visl	nay Sen	niconduc	ctors pro	oduct				
	2	- Cur	rent rati	ng (8 = 8	8 A)					
	3	- Circ	cuit conf	iguratior	ו:					
		E =	single o	liode						
	4	- Pac	kage id	entifier:						
		W =	= D-PAK	(						
	5	- H=	H = hyperfast recovery							
	6	- Vol	Voltage rating (06 = 600 V)							
	7	- FN	FN = TO-252AA							
	8	- • N	• None = tube							
		• T	• TR = tape and reel							
		• T	<ul> <li>TRL = tape and reel (left oriented)</li> </ul>							
		• TI	RR = tap	be and r	eel (righ	nt orient	ed)			
	9	- H=	H = AEC-Q101 qualified							
	10	- Env	Environmental digit:							

M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)							
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION				
VS-8EWH06FNHM3	75	3000	Antistatic plastic tube				
VS-8EWH06FNTRHM3	2000	2000	13" diameter reel				
VS-8EWH06FNTRRHM3	3000	3000	13" diameter reel				
VS-8EWH06FNTRLHM3	3000	3000	13" diameter reel				

LINKS TO RELATED DOCUMENTS						
Dimensions	www.vishay.com/doc?95519					
Part marking information	www.vishay.com/doc?95518					
Packaging information	www.vishay.com/doc?95033					
SPICE model	www.vishay.com/doc?96114					

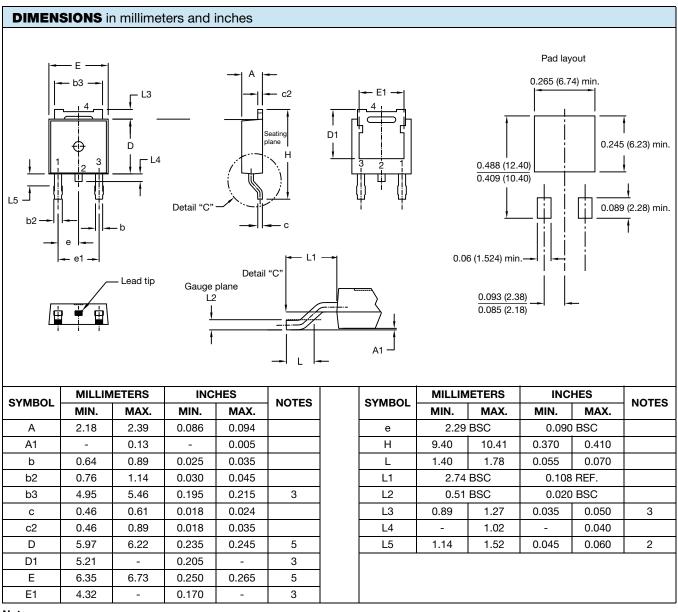


www.vishay.com

# **Outline Dimensions**

**Vishay Semiconductors** 

# DPAK (TO-252AA)



Notes

<sup>(1)</sup> Dimensioning and tolerancing as per ASME Y14.5M-1994

<sup>(2)</sup> Lead dimension uncontrolled in L5

<sup>(3)</sup> Dimension D1, E1, L3 and b3 establish a minimum mounting surface for thermal pad

<sup>(4)</sup> Dimensions D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

<sup>(5)</sup> Outline conforms to JEDEC<sup>®</sup> outline TO-252AA





www.vishay.com

Vishay

## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.